8F-1, No.51, Sec.1, MinSheng E.Rd • Taipei 104 • Taiwan (R.O.C.)

Tel: 886-2-25652000 • Fax: 886-2-2551-5250 • E-mail: sales@temstron.com

SPECIFICATION



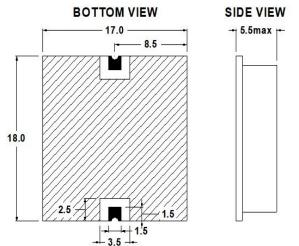
Dual Band SMD Filter

Part No.:	Written by	Checked by	Approval
Customer:	EL Loi	DU liona	CV Chang
Date: 2023.12.01	FL Lai	PH Jiang	CK Chang

Lot No.: Q'ty: pcs

ELECTRICAL SPECIFICATIONS						
	ITEM	CH1	CH2	UNIT		
1	Center freq[f0]	1227.0	1590.0	MHz		
2	Bandwidth [BW]	[1212.0~1242.0]	[1565.0~1615.0]	MHz		
3	Insertion Loss in BW	2.0 max	2.0 max	dB		
4	Pass Band Ripple	0.5 max	0.5 max	dB		
5	VSWR in BW	1.4 max	1.4 max	Ratio		
6	Stop Band Rejection	30 dB min. @ [1303.0~1503.0]		MHz		
7	Input Power	2.0		W		
8	In/Out Impedance	50.0		Ω		
9	Operation Temperature Range	-40°C to +85°C		°C		

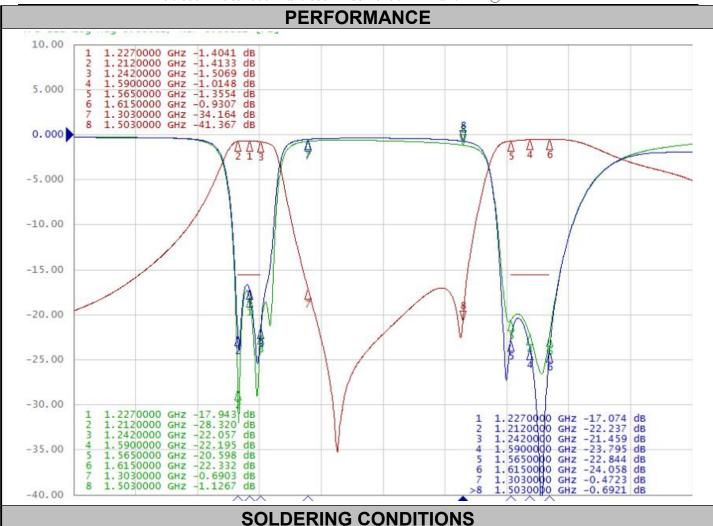
MECHANICAL SPECIFICATIONS



I/O PORT GROUND **TOLERANCE: ±0.30** UNIT: mm



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- 1. Please ensure that it is a good ground area between GROUND and I/0 PORT when you solder the product. In order to have a good grounding, please fix welding side pin at the bottom after reflow soldering.
- 2. The below is recommended reflow temperature curve. Due to different substrate and reflow soldering equipment, actual temperature curve is confirmed by case.
- 3. If it occurs to need manual soldering, the temperature should be 350°C,but not over 3 times, and reflow and manual soldering should not be over 3 times.
- 4. Soldering can only be for PCB packaging product. It is forbidden for ceramic dielectric product.

